

ThermaTEC™ Series HT4-12-F2-4040

Legacy Product



Americas: +1.919.597.7300 Europe: +46.31.420530 Asia: +86.755.2714.1166 ets.sales@lairdtech.com www.lairdtech.com **Note:** This product has reached end of production and is available on a limited basis only. This product series has been replaced with the improved HiTemp ETX Series product offering. Consider using 387004938 / ETX4-12-F2-4040-TA-RT-W6 HiTemp ETX Series module as a replacement.

The ThermaTEC™ Series of thermoelectric modules (TEMs) are designed to operate under cycling conditions or high temperature applications. This product line is available in multiple configurations and is ideal for applications that require both heating and cooling mode (reverse polarity) or power generation. Assembled with proprietary solder construction, Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics, the ThermaTEC Series is designed for higher current and larger heat-pumping applications.

FEATURES

- Thermal cycling durability
- Power cycling reliability
- · Precise temperature control
- Strong lead attachment
- RoHS compliant
- Continuous operation at high temperatures

APPLICATIONS

- Analytical instrumentation
- PCR cyclers
- Thermal test sockets
- · Electronic enclosure cooling
- Chillers (liquid cooling)
- Power generation

SPECIFICATIONS

| TECHNICAL | | | | | | |
|---------------------------|------|------|--|--|--|--|
| Hot Side Temperature (°C) | 25°C | 50°C | | | | |
| Qmax (Watts) | 33.0 | 36.0 | | | | |
| Delta Tmax (°C) | 64 | 75 | | | | |
| Imax (Amps) | 3.8 | 3.8 | | | | |
| Vmax (Volts) | 14.5 | 16.4 | | | | |
| Module Resistance (Ohms) | 3.49 | 3.93 | | | | |

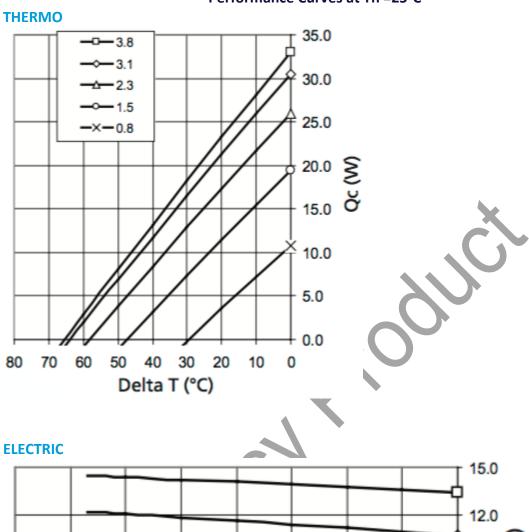
| SUFFIX | THICKNESS (PRIOR TO TINNING) | FLATNESS & PARALLELISM | HOT FACE | COLD FACE | LEAD LENGTH |
|--------|------------------------------------|------------------------|----------|-----------|-------------|
| 11 | 0.163"±0.005" | 0.002" /0.0035" | Lapped | Lapped | 6.0" |
| TA | 0.163"±0.001" | 0.001"/0.001" | Lapped | Lapped | 6.0" |
| TB | 0.163"±0.0005" | 0.0005"/0.0005" | Lapped | Lapped | 6.0" |

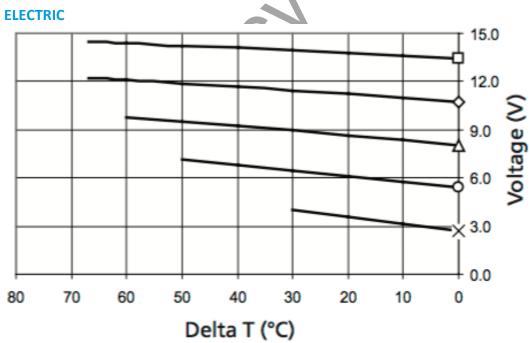
SEALING OPTIONS

| SUFFIX | SEALANT | COLOR | TEMP RANGE | DESCRIPTION |
|--------|---------|-------|---------------|--|
| RT | RTV | White | -60 to 204 °C | Non-corrosive, silicone adhesive |
| EP | Ероху | Black | -55 to 150 °C | Low density syntactic foam epoxy encapsulant |

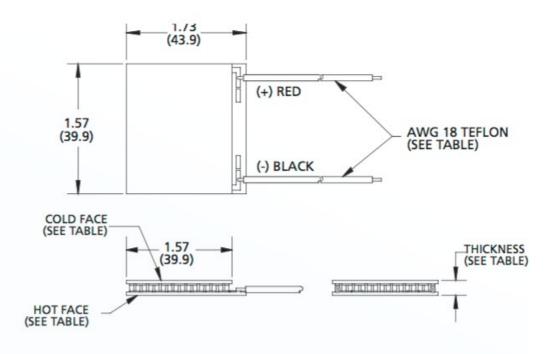


Performance Curves at Th =25°C









Ceramic Material: Alumina (Al₂O₃) Solder Construction: 271°C, Proprietary

NOTES

- 1. Max operating temperature: 175°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation

LAIRD-ETS-HT4-12-F2-4040-DATA-SHEET-101416

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